

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
1	BRS	L1	148	((organic) with (dielectric or insulat\$3)) with (etch adj stop\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 15:33			0
2	BRS	L8	148	1 same etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 12:07			0
3	BRS	L15	28	8 and @pd<=20000430	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 13:11			0
4	BRS	L22	4	15 and damascene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 15:38			0
5	BRS	L29	38	5,565,384	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 13:07			0
6	BRS	L36	0	etch\$4 with (via or opening or hole) with trench with (organic adj (dielectric or insulati\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 13:10			0
7	BRS	L43	17	etch\$4 with (via or opening or hole) with trench with (organic adj (dielectric or insulati\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 17:10			0
8	BRS	L57	0	50 and @pd<=20000430	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 16:41			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
9	BRS	L50	17	etch\$4 with (via or opening or hole) with trench with (organic adj (dielectric or insulat\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 13:12			0
10	BRS	L64	78	(inorganic) with (dielectric or insulat\$3) with (etch adj stop\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 15:34			0
11	BRS	L71	57	64 and damascene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 15:38			0
12	BRS	L78	6	71 and @pd<=20000430	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 16:41			0
13	BRS	L85	22	etch\$4 with (via or opening or hole) with trench with (inorganic adj (dielectric or insulat\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/11 17:11			0